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BMD-340 Module for Bluetooth 5 and 802.15.4

The BMD-340 is an advanced, highly flexible, ultra-low power multiprotocol SoM that enables Bluetooth 5 (BLE) and IEEE 802.15.4 (Thread and Zigbee) connectivity for portable, extremely low power embedded systems. With an ARM® Cortex™-M4F CPU, integrated 2.4GHz transceiver, and an integrated antenna, the BMD-340 provides a complete RF solution allowing faster time to market with reduced development costs. Providing full use of the Nordic nRF52840's capabilities and peripherals, the BMD-340 can power the most demanding applications, all while simplifying designs and reducing BOM costs. The BMD-340 is an ideal solution for designs that require the latest Bluetooth 5 features or 802.15.4 based networking for Thread. Increased integration with built in USB and 5.5V compatible DC/DC supply reduces design complexity and BOM cost, while expanding possible applications. BMD-340 designs are footprint compatible with the BMD-300/301, providing low-cost flexibility for tiered product lineups.











1. Features

- Based on the Nordic nRF52840 SoC
- Bluetooth 5 Long Range, 2Mbs, and Advertising **Extension support**
- IEEE 802.15.4 with Thread and Zigbee support
- Complete RF solution with integrated antenna
- Integrated DC-DC converter
- No external components required
- ARM[®] Cortex[™]-M4F 32-bit processor
- ARM® TrustZone® Cryptocell 310 security
- True Random Number Generator
- Serial Wire Debug (SWD)
- Nordic SoftDevice ready
- 1MB embedded flash memory
- 256kB RAM
- 48 General Purpose I/O Pins
- -40C to +85 Temperature Range
- FCC: 2AA9B10

- 12-bit/200KSPS ADC
- One Full-Speed USB (12Mbps)
- Four SPI Master/Slave (8 Mbps)
- Quad SPI with Execute in Place (XIP)
- Low power comparator
- Temperature sensor
- Two 2-wire Master/Slave (I2C compatible)
- 12S audio interface
- Two UARTs (w/ CTS/RTS and DMA)
- 20 channel CPU independent Programmable Peripheral Interconnect (PPI)
- Quadrature Demodulator (QDEC)
- 128-bit AES HW encryption
- 5 x 32bit, 3 x 24bit Real Timer Counters (RTC)
- NFC-A tag interface for OOB pairing
- Dimensions: 15.0 x 10.2 x 1.9mm
- IC: 12208A-10

2. Applications

- Climate Control
- **Lighting Products**
- Safety and Security
- **Home Appliances**
- **Access Control**

- Internet of Things
- Home Health Care
- **Advanced Remote Controls**
- **Smart Energy Management**
- **Low-Power Sensor Networks**
- Interactive Entertainment Devices
- **Environmental Monitoring**
- **Hotel Automation**
- Office Automation









3. Ordering Information

Email modules@rigado.com for quotes and ordering or visit www.rigado.com/BMD-340

Part Number	Description
BMD-340-A-R	BMD-340 module, Rev A, nRF52840-QIAA, Tape & Reel, 1000 piece multiples
BMD-340-ES1	BMD-340 module, ENG, nRF52840-QIAA, Engineering A silicon
BMD-340-ES2	BMD-340 module, ENG, nRF52840-QIAA, Engineering B silicon
BMD-340-A-EVK	BMD-340-A Evaluation Kit with Segger J-Link programmer
BMD-340-ES1-EVK	BMD-340-ES1 Evaluation Kit with Segger J-Link programmer

Table 1 – Ordering Part Numbers

4. Block Diagram

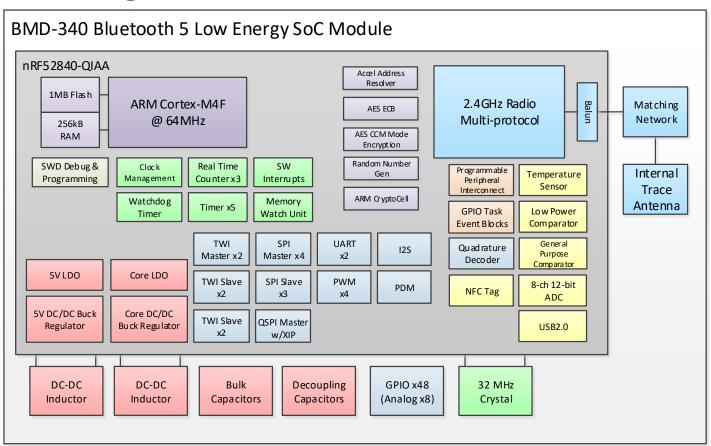


Figure 1 – Block Diagram

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5. Quick Specifications

Bluetooth				
Version	5.0 (Bluetooth Smart) Concurrent Central & Peripheral (S140)			
Security	AES-128			
LE connections	Un to 8 a	as Central, 1 as Peripheral	Observe	r. Broadcaster (S140)
IEEE 802.15.4	op to o		, 0 000. 10	., 5.000000000. (62.10)
Thread Stack	OpenThr	ead, Thread 1.1 certified		
Thread Security		, ARM® Cryptocell acceler	ated	
Zigbee Stack		.0 (Certification Pending)		
Radio	Zigbee 3	is (sertification renaing)		
Frequency	2.402GH	z to 2.480GHz		
Modulations		1 Mbps and 2Mbps, QPSK	at 250kh	ns
	+8 dBm	T Mibps and Zimbps, Qr Si	at 250Kb	μ3
Transmit power		(20.4h-na) OC al Dua (10.4h-na	.) 102 (1	25lana DI 5) 400 dDm /IFFF 002 45 4)
Receiver sensitivity			5), -103 (1	.25ksps BLE), -100 dBm (IEEE 802.15.4)
Antenna	Integrate	ed		
Current Consumption	DCDC on a	blad	1/1 0 m	A 49 mA
TX only @ +8 dBm, 0 dBm @ 3V, TX only @ +8 dBm, 0 dBm	DCDC ena	iblea		A, 4.8 mA A, 10.6 mA
RX only @ 1 Mbps @ 3V, DCDC	nahled		4.6 mA	
RX only @ 1 Mbps	mabica		9.9 mA	
CPU @ 64MHz from flash, from	RAM			, 5.2mA
CPU @ 64MHz from flash, from		, DCDC enabled	3.3 mA	, 2.8mA
System Off, On (Supply on VDD)	, no RAM r	etention	0.4 μΑ,	0.97 μΑ
System Off, On (Supply on VDD),	full 256kB	RAM retention	1.86 μΑ	Α, 2.35μΑ
Dimensions				
	Length	15.0 mm ± 0.3mm		
BMD-340	Width	10.2 mm ± 0.3mm		
Hardware	Height	1.9 mm ± 0.1mm		
Haluwale	SPI Mast	er/Slave x4		I2S x1
	Quad SP			PWM x12
Interfaces	UART x2			PDM x1
	Two-Wir	e Master/Slave (I2C) x2		USB 2.0 x1
	GPIO x48			Analog input x8
_		V to 3.6V, 1.75V required	to start D	OCDC
Power supply		.5V to 5.5V	ration)	
Temperature Range	-40 to +8	35V to 5.5V (For USB ope	ationj	
Certifications	10 10 10 1			
Certifications	ECC nart	15 modular certification		
FCC	BMD-340 FCC ID: 2AA9B10			
IC	Industry Canada RSS-247 modular certification			
	BMD-340 IC: 12208A-10			
CE		89-1 V2.1.1& 3.1 (89-17 V3.1.1	b): Electro	omagnetic Compatibility
CL			Effective	use of spectrum allocated
Australia / New Zealand				quipment and systems – Short range devices
Bluetooth		O RF-PHY Component (Tes	-	
1000000	,		,	, =

Table 2 – Quick Specifications

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6. Pin Descriptions

6.1 BMD-340

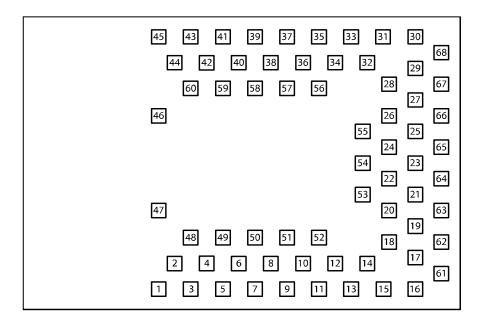


Figure 2 – BMD-340 Pin out (Top View)

Pin description

Pin	Name	Direction	Description
6	P0.25	In/Out	GPIO
7	P0.26	In/Out	GPIO
8	P0.27	In/Out	GPIO
9	P0.28	In/Out	GPIO/AIN4 ²
10	P0.29	In/Out	GPIO/AIN5 ²
11	P0.30	In/Out	GPIO/AIN6 ²
12	P0.31	In/Out	GPIO/AIN7 ²
13	P0.00	In/Out	GPIO/XTAL1 (32.768kHz)
14	P0.01	In/Out	GPIO/XTAL2 (32.768kHz)
15	P0.02	In/Out	GPIO/AIN0 ²
19	P0.03	In/Out	GPIO/AIN1 ²
20	P0.04	In/Out	GPIO/AIN2
21	P0.05	In/Out	GPIO/AIN3
22	P0.06	In/Out	GPIO
23	P0.07	In/Out	GPIO/TRACECLK
24	P0.08	In/Out	GPIO
25	P0.09	In/Out	GPIO/NFC1 ²
26	P0.10	In/Out	GPIO/NFC2 ²
27	P0.11	In/Out	GPIO/TRACEDATA[2]
28	P0.12	In/Out	GPIO/TRACEDATA[1]
31	P0.13	In/Out	GPIO
32	P0.14	In/Out	GPIO

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Pin	Name	Direction	Description	
33	P0.15	In/Out	GPIO	
34	P0.16	In/Out	GPIO	
35	P0.17	In/Out	GPIO	
36	P0.21	In/Out	GPIO	
37	P0.19	In/Out	GPIO	
38	P0.20	In/Out	GPIO	
39	P0.18	In/Out	GPIO/RESET	
40	P0.22	In/Out	GPIO	
41	P0.23	In/Out	GPIO	
42	P0.24	In/Out	GPIO	
43	SWCLK	In	SWD Clock	
44	SWDIO	In/Out	SWD IO	
48	P1.05	In/Out	GPIO ²	
49	P1.06	In/Out	GPIO ²	
50	P1.07	In/Out	GPIO ²	
51	P1.08	In/Out	GPIO	
52	P1.09	In/Out	GPIO/TRACEDATA[3]	
53	P1.10	In/Out	GPIO ²	
54	P1.11	In/Out	GPIO ²	
56	P1.00	In/Out	GPIO/TRACEDATA[0]/SWO	
57	P1.01	In/Out	GPIO ²	
58	P1.02	In/Out	GPIO ²	
59	P1.03	In/Out	GPIO ²	
60	P1.04	In/Out	GPIO ²	
61	P1.12	In/Out	GPIO ²	
62	P1.13	In/Out	GPIO ²	
63	P1.14	In/Out	GPIO ²	
64	P1.15	In/Out	GPIO ²	
67	USB-D-	In/Out	USB Data -	
68	USB-D+	In/Out	USB Data +	
66	VBUS	Power	USB PHY supply: 4.35V to 5.5V in	
			Connect to USB Host device 5V supply LV Mode: 1.7V to 3.6V in	
17	VCC ¹	Power In/Out	HV Mode: 1.8V to 3.3V supply out ³	
	VCCH ¹	Power	LV Mode: Connect to VCC	
65			HV Mode: 2.5V to 5.5V in	
1, 2, 3, 4, 5, 16, 18, 29, 30, 45, 46, 47, 55	GND	Power	Electrical Ground	

Note 1: An internal $4.7\mu\text{F}$ bulk capacitor is included on the module. However, it is good design practice to add additional bulk capacitance as required for your application, i.e. those with heavy GPIO usage and/or current draw.

Note 2: These pins are in close proximity to the nRF52 radio power supply and antenna pins. Radio performance parameters, such as sensitivity, may be affected by high frequency digital I/O with large sink/source current on these pins. Nordic recommends using only low frequency, low-drive functions when possible.

Note 3: In HV mode, VCC acts as a regulated supply that can power other external devices. The voltage output of VCC can be configured in software but is limited to no more than VCCH-0.3V. In System Off mode VCC can supply no more than 1mA.



6.2 Peripheral Pins

The BMD-340 features a pin muxing system that allows most internal peripherals, such as UART and SPI, to be used on any GPIO pin. This freedom in pin choice enables better optimization of designs and PCB layout. Note that only one peripheral signal can be muxed to a GPIO pin at a time. Some functions are restricted to certain pins due to additional internal circuitry required by the interface. These include: Trace signals, analog inputs, XTAL signals, USB signals, SWD interface, and reset. See Table 4 below for details:

Peripheral	Signal	Pin Options
UARTO, UART1		
I2C0, I2C1		
SPIO, SPI1, SPI2, SPI3		
12S0	All	P0.00-P0.31, P1.00-P1.15
QSPI0		
PWM0, PWM1, PWM2, PWM3		
PDN0		
ADC COMP LECOME	A.I.I	P0.02-P0.05, P0.28-P0.31
ADC, COMP, LPCOMP	All	(AINO-AIN7)
NEC	NFC1	P0.09
NFC	NFC2	P0.10
Reset	RESET	P0.18
	TRACECLK	P0.07
	SWO/TRACEDATA[0]	P1.00
Trace	TRACEDATA[1]	P0.12
	TRACEDATA[2]	P0.11
	TRACEDATA[3]	P1.09
SWD	SWD Clock	SWCLK
3000	SWD IO	SWDIO
22 769kHz Crustal	XTAL1	P0.00
32.768kHz Crystal	XTAL2	P0.01
USB	USB Data +	USB-D+
USB	USB Data -	USB-D-

Table 4 – Peripheral Pin Options

Note: Some peripherals on the BMD-340 share the same memory location for their registers. This means that only one of these peripherals can be used at a time. It is possible to switch between peripherals that share the same register location by clearing and reinitializing the associated configuration registers. See the Nordic Semiconductor nRF52840 Product Specification for details.

Peripheral ID	Base Address	Shared P	eripherals	
3	0x40003000	SPI0	I2C0	
4	0x40004000	SPI1	I2C1	

Table 5 – Peripherals with Shared Registers

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6.3 BMD-300 Series Footprint Compatibility and Migration

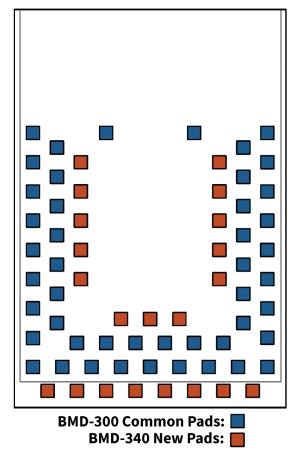


Figure 3 – BMD-340 and BMD-300/301 Footprint Comparison

The BMD-340 footprint has been designed to allow for backwards compatibility with the BMD-300 and BMD-301 modules with pins 1 through 47 of the BMD-340 directly mapping to the same pin numbers on the BMD-300/300. This allows BMD-300 and BMD-301 modules to be placed directly onto the BMD-340 footprint for easy migration and enabling tiered product design. Generally, all pin names and functions remain the same, except for some differences noted below. Pins 48 through 68 of the BMD-340 footprint are new pads used for new features that are not present on the BMD-300/301 modules, such as USB interface and additional GPIO and power connections.



Figure 4 – BMD-300 Module Soldered to BMD-340 Footprint

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6.3.1 BMD-300/301 to BMD-340 Pad Differences

Due to changes in the nRF52840 SoC used by the BMD-340, not all functions (such as SWO/TRACE signals) are found on the same pins as on the BMD-300/301. Particularly of note is the reset pin function which on the BMD-340 is now available on P0.18 instead of P0.21 as on the BMD-300/301. To maintain pin for pin compatibility of the reset signal, P0.18 and P0.21 have swapped pad locations on the BMD-340 footprint. These differences are detailed in Table 6 below:

Pin	BMD-300/301 Name	BMD-300/301 Function	BMD-340 Name	BMD-340 Function
39	P0.21	GPIO/RESET	P0.18	GPIO/RESET
38	P0.20	GPIO/ TRACECLK	P0.20	GPIO
36	P0.18	GPIO/TRACEDATA[0]/SWO	P0.21	GPIO
34	P0.16	GPIO/TRACEDATA[1]	P0.16	GPIO
33	P0.15	GPIO/TRACEDATA[2]	P0.15	GPIO
32	P0.14	GPIO/TRACEDATA[3]	P0.14	GPIO
23	P0.07	GPIO	P0.07	GPIO/TRACECLK
56	N/A	N/A	P1.00	GPIO/TRACEDATA[0]/SWO
28	P0.12	GPIO	P0.12	GPIO/TRACEDATA[1]
27	P0.11	GPIO	P0.11	GPIO/TRACEDATA[2]
52	N/A	N/A	P1.09	GPIO/TRACEDATA[3]

Table 6 – BMD-300/301 to BMD-340 Pad Differences

6.3.2 BMD-300/301 to BMD-340 Design Migration

Existing designs incorporating the BMD-300 or BMD-301 module can be migrated over to the BMD-340 with the addition of a single footprint pad for VCCH (pin 65). This migration option is only suitable for applications that do not require the new USB interface, additional GPIO, or higher supply voltage functionality. The VCCH pad must be present and electrically connected to the same supply as VCC in order for the module to operate correctly. Vias underneath the BMD-340 should be tented to avoid shorts to unused module pads. Firmware written for the BMD-300/301 can generally be ported to the BMD-340 with minimal effort. See the Nordic Semiconductor SDK documentation for details.

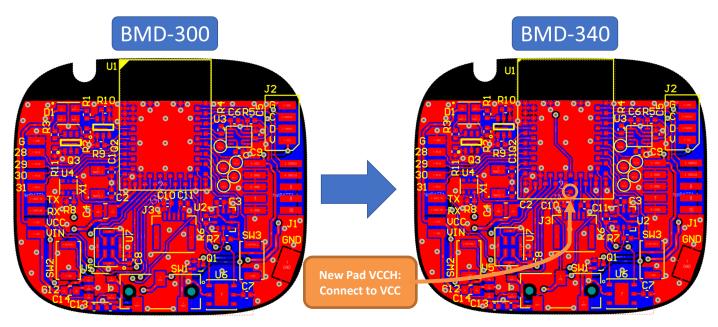


Figure 5 – BMD-300 to BMD-340 Migration Example

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Using the BMD-340 minimal footprint, with only the additional VCCH pad added, allows BMD-300 designs to gain the following BMD-340 features with typically minor layout re-work:

- Bluetooth 5 long range modes
- IEEE 802.15.4 (Thread and Zigbee) connectivity
- Doubled Flash memory (1MB vs. 512kB)
- Quadrupled RAM (256kB vs. 64kb)
- ARM® TrustZone® Cryptocell 310 security co-processor

To take advantage of new hardware features, such as the additional UART and Quad SPI interface, the full BMD-340 footprint should be used. Designs that require the 5V DCDC converter, trace interface, USB interface, or the additional GPIO (P1.00-P1.15) must use the full BMD-340 footprint.

Note: Since the BMD-300 can be soldered to the full BMD-340 footprint, it is highly recommended that all new BMD-300 and BMD-340 projects use the full BMD-340 footprint. When migrating designs, the full BMD-340 footprint should be used whenever possible as it is better suited for use with mass production SMT processing.

6.4 BMD-340 Fanout Example

The following figure is a BMD-340 fanout example on a simple 2-layer PCB. This example is powered via VCCH from a USB connection. See Section 7.3 for details on power and DCDC operation.

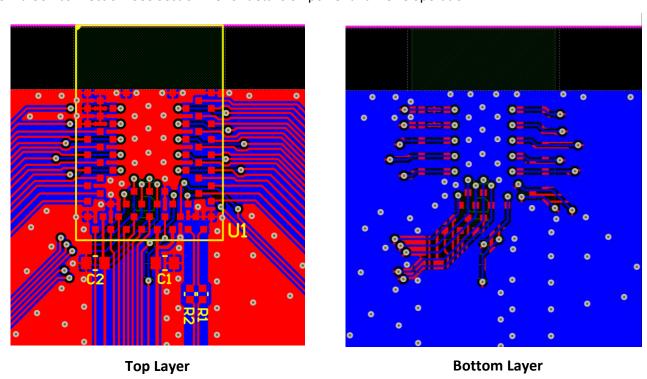


Figure 6 – BMD-340 2 Layer Fanout Example

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7. Electrical Specifications

7.1 Absolute Maximum Ratings

Symbol	Parameter	Min.	Max.	Unit
V _{CC_MAX}	Voltage on VCC supply pin	-0.3	3.9	V
V _{CCH_MAX}	Voltage on VCCH supply pin	-0.3	5.8	V
V _{BUS_MAX}	Voltage on VBUS Supply pin	-0.3	5.8	V
V _{IO_MAX}	Voltage on GPIO pins (V _{CC} > 3.6V)	-0.3	3.9	V
V _{IO_MAX}	Voltage on GPIO pins (V _{CC} ≤ 3.6V)	-0.3	V _{CC} + 0.3V	V
Ts	Storage Temperature Range	-40	125	°C

Table 7 – Absolute Maximum Ratings

7.2 Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{CC_IN}	VCC operating supply voltage in	1.7	3.0	3.6	V
V _{CC_START}	VCC DCDC starting voltage	1.75	-	_	V
V _{CCH_HV}	VCCH operating supply voltage in	2.5	5.0	5.5	V
V_{BUS_IN}	VBUS operating supply voltage in	4.35	5.0	5.5	V
T _{R_VCC}	VCC Supply rise time (0V to 1.7V)	-	-	60	ms
T _{R_VCCH}	VCCH Supply rise time (0V to 3.7V) ¹	-	-	1	ms
T _A	Operating Ambient Temperature Range	-40	25	85	°C

Note 1: Applies when module is configured to use HV mode. When using LV mode T_{R_VCC} applies. See Nordic nRF52840 Rev 1 errata [202] for details on T_{R_VCCH} requirement.

Table 8 – Operating Conditions

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7.3 Power and DCDC Configuration

Important Note Regarding REG0: Initial mass production silicon (Nordic Rev 1) for the nRF52840 includes some errata that affect the REG0 regulator. The REG0 DC-DC converter mode cannot be used reliably. The LDO mode of REG0 can be used in High Voltage mode but when applying power the input voltage must have a rise time of 1ms or less. Due to the rise time constraint and higher current consumption of LDO mode compared to DCDC, High Voltage mode should be considered non-functional for most applications and should not be used on ES2 and Revision A BMD-340 modules. See Nordic nRF52840 errata 197 and 202 for more details. These errata are expected to be corrected in future production silicon releases and subsequent revisions of the BMD-340 module. Contact Rigado for timing and details.

The BMD-340 has two internal regulator stages that each contain an LDO and DCDC regulator. The first regulator, REG0, is fed by the VCCH pin and can accept a source voltage of 2.5V to 5.5V. The output of REG0 is connected to the VCC pin and the input of the second regulator stage REG1. REG1 supplies power to the module core and can accept an input source voltage of 1.7V to 3.6V. Depending on how the VCC and VCCH pins are connected, the module will operate in one of two modes: Normal/Low Voltage (LV) or High Voltage (HV). The voltage present on the VCC pin is always the GPIO high logic level voltage, regardless of power mode.

To enter LV Mode, the same source voltage is applied to both the VCC and VCCH pins causing REG0 to automatically shut down leaving only the REG1 stage active. To enter HV, the source voltage is only applied to VCCH causing the VCC pin to become an output source supplied by REG0.

Mode	Pin	Name	Connection
Normal (I)/)	17	VCC	1.7V to 3.6V source in
Normal (LV)	65	VCCH	Same source as VCC
11; ab \/alta aa /11\/\	17	VCC	1.8V to 3.3V supply out
High Voltage (HV)	65	VCCH	2.5V to 5.5V source in

Table 9 - Power Mode Pin Connections

Important: in both LV and HV mode, the GPIO logic level voltage is determined by the VCC pin. In HV mode, all external devices that are connected to the BMD-340's GPIO must either be powered by the module (from VCC) or use level translation.

REGO can supply a maximum current of ~50mA for the module and external circuits in System On Mode and 1mA in System Off Mode. External circuits powered from VCC in HV mode should be limited to no more than 20mA to ensure stability.

7.3.1 USB Power

The USB interface on the BMD-340 can be used when the module is in either Normal (LV) or High Voltage (HV) mode. The BMD-340 USB PHY is powered by a dedicated, internal LDO regulator that is fed by the VBUS pin (66). This means that applying power to only the VBUS pin will not power the rest of the module. In order for the USB PHY to operate, VBUS must be externally powered.

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7.3.2 Normal (LV) Power Mode Examples

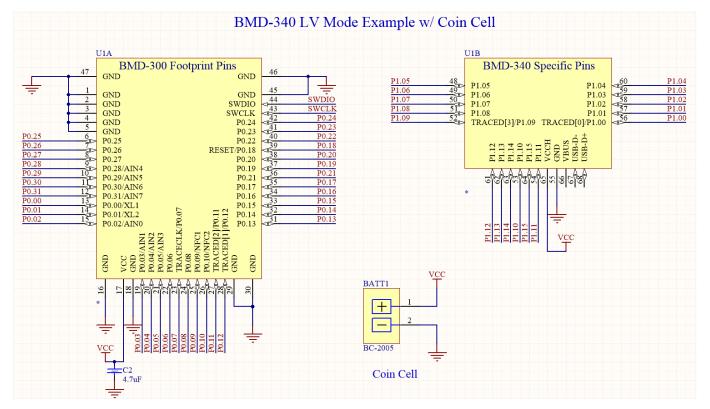


Figure 7 – LV Mode w/ Coin Cell Example

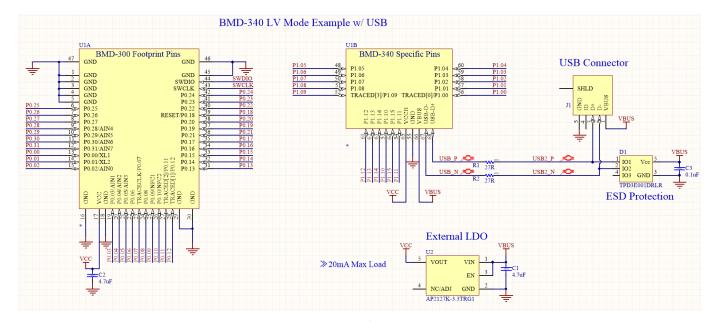


Figure 8 – LV Mode Example w/ USB and External Regulator

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7.3.3 High Voltage (HV) Power Mode Examples

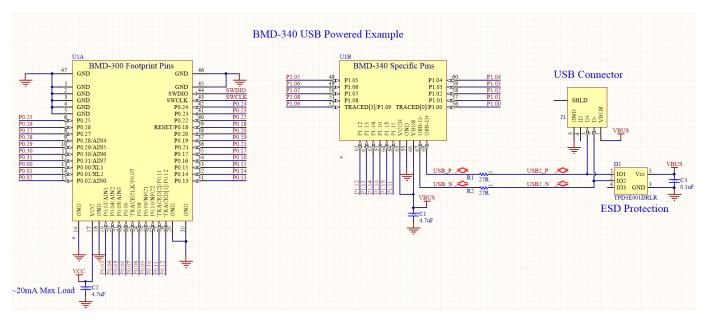


Figure 9 – USB Powered HV Mode Example

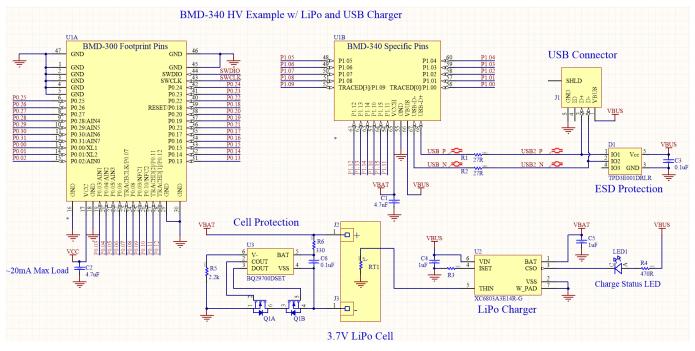


Figure 10 – LiPo Powered HV Example w/ USB Charger

Important: the LiPo circuit above is meant to be a generic example of how the BMD-340's power modes can be used. Great care must be taken when integrating Lithium-Ion batteries into a design. Protection circuits suitable for the type of battery used and the application must always be implemented.

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7.4 General Purpose I/O

The general purpose I/O is organized as two ports enabling access and control of the 48 available GPIO pins. The first port allows access of P0.00 to P0.31, similar to the one port available on the BMD-300/301. The second port, new to the BMD-340, allows access to P1.00 to P1.15. Each GPIO can be accessed individually with the following user configurable features:

- Input/output direction
- Output drive strength
- Internal pull-up and pull-down resistors
- Wake-up from high or low level triggers on all pins
- Trigger interrupt on all pins
- All pins can be used by the PPI task/event system; the maximum number of pins that can be interfaced through the PPI at the same time is limited by the number of GPIOTE channels
- All pins can be individually configured to carry serial interface or quadrature demodulator signals

Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{IH}	Input High Voltage	0.7 x V _{CC}	-	V_{cc}	V
V_{IL}	Input Low Voltage V _{SS} - 0.3 x V				V
V _{OH}	Output High Voltage	V _{CC} – 0.4	-	V _{CC}	V
V _{OL}	Output Low Voltage	V_{SS}	-	V _{SS} + 0.4	V
R _{PU}	Pull-up Resistance	11	13	16	kΩ
R _{PD}	Pull-down Resistance	11	13	16	kΩ

Table 10 - GPIO

7.5 Module RESET

GPIO pin P0.18 may be used for a hardware reset. In order to utilize P0.18 as a hardware reset, the UICR registers PSELRESET[0] and PSELRESET[1] must be set alike, to the value of 0x7FFFFFD2. When P0.18 is programmed as RESET, the internal pull-up is automatically enabled. Rigado and Nordic example applications and development kits program P0.18 as RESET.

7.6 Debug & Programming

The BMD-340 supports the two pin Serial Wire Debug (SWD) interface and offers flexible and powerful mechanisms for non-intrusive debugging of program code. Breakpoints, single stepping, and instruction trace capture of code execution flow are part of this support.

The BMD-340 also supports ETM and ITM trace. Trace data from the ETM and the ITM is sent to an external debugger via a 4-bit wide parallel trace port. In addition to parallel trace, the TPIU supports serial trace via the Serial Wire Output (SWO) trace protocol.

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7.7 Clocks

The BMD-340 requires two clocks, a high frequency clock and a low frequency clock.

The high frequency clock is provided on-module by a high-accuracy 32-MHz crystal as required by the nRF52840 for radio operation.

The low frequency clock can be provided internally by an RC oscillator or synthesized from the fast clock; or externally by a 32.768 kHz crystal. An external crystal provides the lowest power consumption and greatest accuracy. Using the internal RC oscillator with calibration provides acceptable performance for BLE applications at a reduced cost and slight increase in power consumption. Note: the ANT protocol requires the use of an external crystal.

32.768 kHz Crystal (LFXO)

Symbol	Parameter	Тур.	Max.	Unit
F _{NOM_LFXO}	Crystal frequency	32.768 - kHz		
F _{TOL_LFXO_BLE}	Frequency tolerance, BLE applications	s - ±250 ppm		
C_{L_LFXO}	Load Capacitance	-	12.5	pF
C _{0_LFXO}	Shunt Capacitance - 2 pF			pF
R _{S_LFXO}	Equivalent series resistance	-	100	kΩ
C _{pin}	Input Capacitance on XL1 & XL2 pads	4	-	pF

Table 11 - 32.768 kHz Crystal

32.768 kHz Oscillator Comparison

Symbol	Parameter		Тур.	Max.	Unit
I_{LFXO}	Current for 32.768kHz Crystal Oscillator	_	0.23	-	μΑ
I _{LFRC}	Current for 32.768kHz RC Oscillator - 0.7 1				
I _{LFSYNT}	Current for 32.768kHz Synthesized Oscillator	- 100 - μA			μΑ
f _{TOL_LFXO_BLE}	Frequency Tolerance, 32.768kHz Crystal Oscillator (BLE Stack) ¹	±250 p _l		ppm	
f _{TOL_LFXO_ANT}	Frequency Tolerance, 32.768kHz Crystal Oscillator (ANT Stack) ¹	-	_	±50	ppm
f _{TOL_LFRC}	Frequency Tolerance, 32.768kHz RC Oscillator	-	-	±2	%
f _{TOL_CAL_LFRC}	Frequency tolerance, 32.768kHz RC after calibration	-	-	±250	ppm
f _{TOL_LFSYNT}	Frequency Tolerance, 32.768kHz Synthesized Oscillator +48		ppm		

Note 1: $f_{TOL_LFXO_BLE\ and}\ f_{TOL_LFXO_ANT}$ are the max allowed for BLE and ANT applications. Actual tolerance depends on the crystal used.

Table 12 – 32.768 kHz Oscillator

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8. Firmware

8.1 Factory Image

The BMD-340 module is not loaded with a factory firmware image. The unique Rigado MAC address printed on the module label and is also programmed into the UICR.

8.2 SoftDevices

Nordic Semiconductor protocol stacks for Bluetooth and ANT are known as SoftDevices. SoftDevices are precompiled, pre-linked binary files. SoftDevices can be programmed in nRF52 series SoCs and are downloadable from the Nordic website. The BMD-340 with the nRF52840 SoC supports the S140 (BLE Central & Peripheral) SoftDevice.

8.2.1 S140

The S140 SoftDevice is a Bluetooth® low energy (BLE) Central and Peripheral protocol stack solution supporting up to eight connections with an additional Observer and a Broadcaster role all running concurrently. The S140 SoftDevice integrates a BLE Controller and Host, and provides a full and flexible API for building Bluetooth Smart nRF52 System on Chip (SoC) solutions. The S140 Softdevice is an extension of the S132 V3.0 Softdevice adding support for Bluetooth 5.

Key Features

- Bluetooth 5 compliant low energy single-mode protocol stack suitable for Bluetooth Smart products
- Concurrent Central, Observer, Peripheral, and Broadcaster roles with up to eight concurrent connections along with one observer and one broadcaster
 - Configurable number of connections and bandwidth per connection to optimize memory and performance
 - Configurable attribute table size
 - Custom UUID support
 - Link layer
 - LL Privacy
 - LE Data Packet Length Extension
 - L2CAP, ATT, and SM protocols
 - LE Secure Connections pairing model
 - GATT and GAP APIs
 - GATT Client and Server
 - Configurable ATT MTU
- Complementary nRF5 SDK including Bluetooth profiles and example applications

- Master Boot Record for over-the-air device firmware update
 - SoftDevice, application, and bootloader can be updated separately
- Memory isolation between the application and the protocol stack for robustness and security
- Thread-safe supervisor-call based API
- Asynchronous, event-driven behavior
- No RTOS dependency
 - Any RTOS can be used
- No link-time dependencies
 - Standard ARM® Cortex®-M4 project configuration for application development
- Support for concurrent and non-concurrent multiprotocol operation
 - Concurrent with the Bluetooth stack using Radio Timeslot API
 - Alternate protocol stack in application space
- Support for control of external Power Amplifiers and Low Noise Amplifiers

8.3 IEEE 802.15.4 (Thread and Zigbee)

IEEE 802.15.4 based protocols, such as Thread and Zigbee, on the BMD-340 are not implemented using a Softdevice. Nordic Semiconductor provides an IEEE 802.15.4 compliant MAC stack which does not require a Softdevice to be loaded to operate. Nordic Semiconductor also provides pre-compiled Thread and Zigbee stacks. See developer.nordicsemi.com/nRF5 SDK/doc/ for more information on developing applications that utilize IEEE 802.15.4.

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8.4 MAC Address Info

The BMD-340 modules comes preprogrammed with a unique MAC address from the factory. The MAC address is also printed on a 2D barcode on the top of the module.



MAC Address: 94:54:93:XX:YY:ZZ

Figure 11 – BMD-340 MAC Address on Label

The 6-byte BLE Radio MAC address is stored in the nRF52840 UICR at NRF_UICR_BASE+0x80 LSB first. Please read the MAC Address Provisioning application note if you are not using the built in bootloader to avoid erasing/overwriting the MAC address during programming. **Important:** If full memory protection is enabled, the UICR cannot be read via the SWD interface. If performing a full-erase, the MAC can then only be recovered from the 2D barcode and human-readable text.

UICR Register:

NRF_UICR + 0x80 (0x10001080): MAC_Addr [0] (0xZZ)
NRF_UICR + 0x81 (0x10001081): MAC_Addr [1] (0xYY)
NRF_UICR + 0x82 (0x10001082): MAC_Addr [2] (0xXX)
NRF_UICR + 0x83 (0x10001083): MAC_Addr [3] (0x93)
NRF_UICR + 0x84 (0x10001084): MAC_Addr [4] (0x54)
NRF_UICR + 0x85 (0x10001085): MAC_Addr [5] (0x94)

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9. Mechanical Data

9.1 Mechanical Dimensions

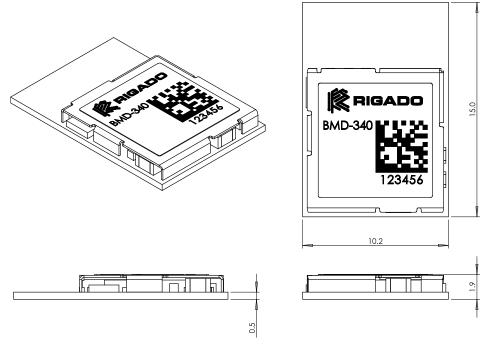


Figure 12 – BMD-340 Module Dimensions

(All dimensions are in mm)

9.2 Recommended PCB Land Pads

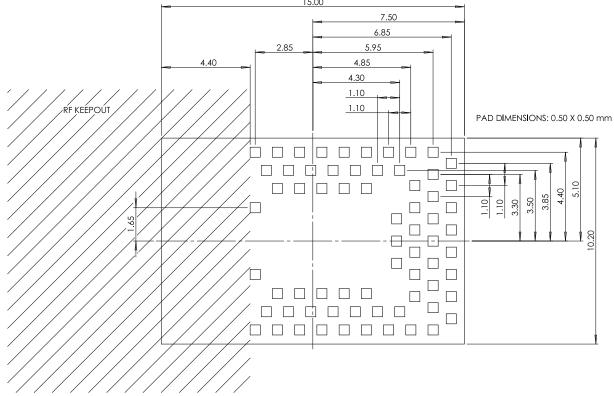


Figure 13 – BMD-340/301 Dimensions (Top View)
(All dimensions are in mm)

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10. Module Marking

IGADO



Figure 14 - BMD-340 Module Marking - Rev A

11. RF Design Notes

11.1 Recommended RF Layout & Ground Plane

The integrated antenna requires a suitable ground plane to radiate effectively.

The area under and extending out from the antenna portion of the module should be kept clear of copper and other metal. The module should be placed at the edge of the PCB with the antenna edge facing out. Reducing the ground plane from that shown in Figure 15 will reduce the effective radiated power.

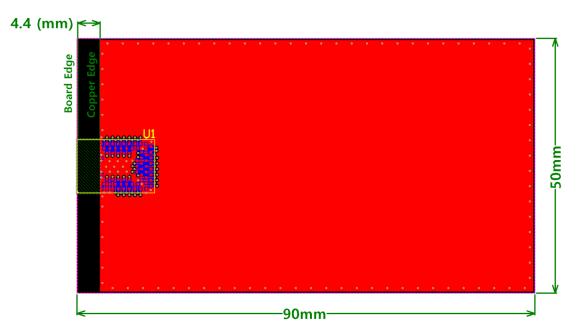


Figure 15 – BMD-340 RF Example based on EVAL Board

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11.2 Mechanical Enclosure

Care should be taken when designing and placing the module into an enclosure. Metal should be kept clear from the antenna area, both above and below. Any metal around the module can negatively impact RF performance.

The module is designed and tuned for the antenna and RF components to be in free air. Any potting, epoxy fill, plastic over-molding, or conformal coating can negatively impact RF performance and must be evaluated by the customer.

11.3 Antenna Patterns

Antenna patterns are based on the BMD-340 Evaluation Kit with a ground plane size of 109mm x 56mm. X-Y-Z orientation is shown in Figure 16:



Figure 16 – X-Y-Z Antenna Orientation

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12. Evaluation Boards

Rigado has developed full featured evaluation boards that provide a complete I/O pin out to headers, on-board programming and debug, 32.768 kHz crystal, power & virtual COM port over USB, BMD-340 USB connector, 64Mb quad SPI Flash, 4 user LEDs, and 4 user buttons. The evaluation boards also provide the option to be powered from a CR2032 coin cell battery or a LiPo battery through a JST-PH connecter, and have current sense resistors and headers to allow for convenient current measurements. Arduino Mega style headers are provided for easy prototyping of additional functions. The evaluation boards also support programming off-board BMD-300/301 and BMD-340 Series modules.

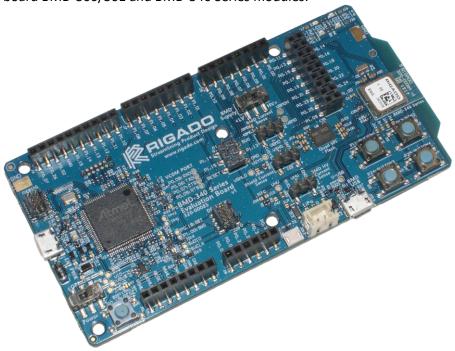


Figure 17 - BMD-340 Evaluation Board

13. Edge Connectivity Solutions

Rigado offers secure and scalable device-to-cloud connectivity solutions with edge computing power that are designed to perfectly interface with Rigado modules and streamline Commercial IoT deployments. The Rigado Cascade platform provides IoT teams with secure edge computing, a containerized application platform and a wide variety of wireless connectivity options — all in a simple 'Edge-as-a-Service' monthly subscription.

Visit www.rigado.com/iot-edge-as-a-service/ or contact Rigado at info@rigado.com for more details.

RIGADO EDGE CONNECTIVITY SOLUTIONS



Cascade for edge connectivity, computing & security

wireless modules

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14. Bluetooth Qualification

The BMD-340 Series modules will be qualified as a Bluetooth Component (tested) for RF-PHY. This allows customers to use different SoftDevices that have been qualified by Nordic without the need to complete additional RF-PHY testing. To achieve Bluetooth End Product qualification, the Rigado RF-PHY QDID can be combined with Nordic QDIDs for the SoftDevice used when filing on the Bluetooth SIG website. The only testing required is for the Bluetooth profiles supported by the customer's product. Products with only custom profiles do not require any additional testing.

BMD-340: RF-PHY Component(Tested) Declaration ID TBD / QDID TBD

15. Regulatory Statements

15.1 FCC Statement:

This device has been tested and found to comply with part 15 of the FCC rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and the receiver
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Operation is subjected to the following two conditions: (1) This device may no cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation. Note: Modification to this product will void the user's authority to operate this equipment.

Note: Modification to this product will void the users' authority to operate this equipment.

15.2 FCC Important Notes

(1) FCC Radiation Exposure Statement

This equipment complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. This equipment complies with Part 15 of the FCC Rules. Operation is subject the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

The devices must be installed and used in strict accordance with the manufacturer's instructions as described in this document.

Caution!

The manufacturer is not responsible for any radio or TV interference caused by unauthorized modifications to this equipment. Such modification could void the user authority to operate the equipment.

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(2) Co-location Warning:

This device and its antenna(s) must not be co-located or operating in conjunction with any other transmitter antenna.

(3) OEM integration instructions:

This device is intended only for OEM integrators under the following conditions:

The antenna and transmitter must not be co-located with any other transmitter or antenna. The module shall be only used with the integral antenna(s) that has been originally tested and certified with this module.

As long as the two (2) conditions above are met, further transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements with this module installed (for example, digital device emission, PC peripheral requirements, etc.)

In the event that these conditions cannot be met (for example certain laptop configuration or co-location with another transmitter), then the FCC authorization for this module in combination with the host equipment is no longer considered valid and the FCC ID of the module cannot be used on the final product. In these and circumstance, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

Caution!

The OEM is still responsible for verifying end product compliance with FCC Part 15, subpart B limits for unintentional radiators through an accredited test facility.

The OEM integrator will be responsible to satisfy SAR/RF exposure requirements when the module integrated into the host device.

(4) End product labeling:

The final end product must be labeled in a visible area with the following:

- BMD-340: "Contains FCC ID: 2AA9B10"
- Any similar wording that expresses the same meaning may be used.

The FCC Statement below should also be included on the label. When not possible, the FCC Statement should be included in the User Manual of the host device.

"This device complies with part 15 of the FCC rules.

Operation is subject to the following two conditions. (1) This device may not cause harmful interference. (2) This device must accept any interference received, including interference that may cause undesired operation."

(5) Information regarding the end user manual:

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as show in this manual (Section 15.2(4)).

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15.3 IC Statement:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

RF exposure warning: The equipment complies with RF exposure limits set forth for an uncontrolled environment. The antenna(s) used for this transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

Avertissement d'exposition RF: L'équipement est conforme aux limites d'exposition aux RF établies pour un incontrôlés environnement. L'antenne (s) utilisée pour ce transmetteur ne doit pas être co-localisés ou onctionner en conjonction avec toute autre antenne ou transmetteur.

15.4 IC Important Notes

1. The OEM integrator must be aware not to provide information to the end user regarding how to install or remove this RF module in the user manual of the end product.

The user manual which is provided by OEM integrators for end users must include the following information in a prominent location.

L'intégrateur OEM doit être conscient de ne pas fournir d'informations à l'utilisateur final sur la manière d'installer ou de retirer ce module RF dans le manuel d'utilisation du produit final.

Le manuel d'utilisation fourni par les intégrateurs OEM pour les utilisateurs finaux doit inclure les informations suivantes dans un emplacement visible.

2. To comply with IC RF exposure compliance requirements, the antenna used for this transmitter must not be co-located or operating in conjunction with any other antenna or transmitter, except in accordance with IC multi-transmitter product procedures.

Pour se conformer aux exigences de conformité de l'exposition RF IC, l'antenne utilisée pour cet émetteur ne doit pas être co-localisée ou fonctionner en conjonction avec une autre antenne ou un autre émetteur, sauf conformément aux procédures du produit multi-émetteur IC.

3. The final system integrator must ensure there is no instruction provided in the user manual or customer documentation indicating how to install or remove the transmitter module except such device has implemented two-ways authentication between module and the host system.

L'intégrateur système final doit s'assurer qu'aucune instruction n'est fournie dans le manuel de l'utilisateur ou dans la documentation du client indiquant comment installer ou retirer le module transmetteur, sauf qu'un tel dispositif a mis en place une authentification bidirectionnelle entre le module et le système hôte.

4. The host device shall be properly labelled to identify the module within the host device. The end product must be labeled in a visible area with the following:

"Contains IC: 12208A-10"

Any similar wording that expresses the same meaning may be used.

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Le périphérique hôte doit être correctement étiqueté pour identifier le module dans le périphérique hôte. Le produit final doit être étiqueté dans une zone visible avec:

"Contains IC: 12208A-10 "

Toute formulation similaire exprimant la même signification peut être utilisée.

The IC Statement below should also be included on the label. When not possible, the IC Statement should be included in the User Manual of the host device.

"This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le onctionnement."

15.5 CE Regulatory

The BMD-340 module is being tested and is expected to be compliant against the following standards. OEM integrators should consult with qualified test house to verify all regulatory requirements have been met for their complete device.

EU - Radio Equipment Directive 2014/53/EU

- ETSI EN 300 328 V 2.1.1
- ETSI EN 301 489-1 V2.1.1
- ETSI EN 301 489-17 V3.1.1

Pending completion of testing, Declarations of Conformity and supporting test reports will be available at www.rigado.com.

15.6 Australia / New Zealand

The BMD-340 module is to be tested to comply with the AS/NZS 4268 :2012+AMDT 1:2013, Radio equipment and systems – Short range devices – Limits and methods of measurement. Pending test completion, the report may be downloaded from www.rigado.com, and may be used as evidence in obtaining permission to use the RCM.

Information on registration as a Responsible Party, license and labeling requirements may be found at the following websites:

Australia: http://www.acma.gov.au/theACMA/radiocommunications-short-range-devices-standard-2004
New Zealand: http://www.rsm.govt.nz/compliance

The A-Tick and C-Tick marks are being migrated to the Regulatory Compliance Mark (RCM). Only Australian-based and New Zealand-based companies who are registered may be granted permission to use the RCM. An Australian-based or New Zealand-based agent or importer may also register as a Responsible Party to use the RCM on behalf of a company not in Australia or New Zealand.

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16. Solder Reflow Temperature-Time Profile

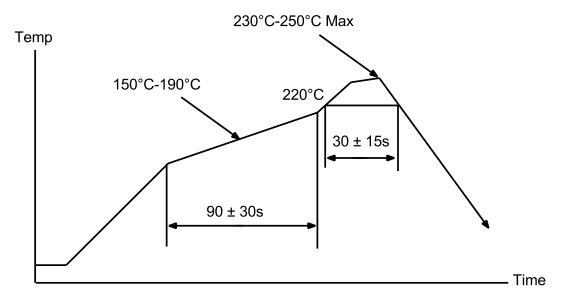


Figure 18 – Reflow Profile for Lead Free Solder

16.1 Moisture Sensitivity Level

The BMD-340 is rated for MSL 3, 168-hour floor life after opening.

17. Packaging and Labeling

17.1 Carrier Tape Dimensions

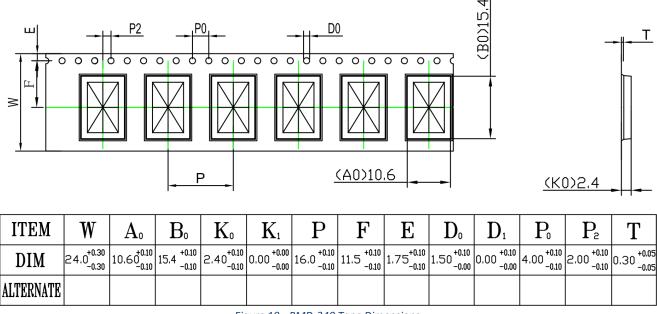


Figure 19 - BMD-340 Tape Dimensions

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17.2 Reel Packaging

Modules come on 330mm reels loaded with 1000 modules. Each reel is placed in an antistatic bag with a desiccant pack and humidity card and placed in a 340x350x65mm box. On the outside of the bag an antistatic warning and reel label are adhered.

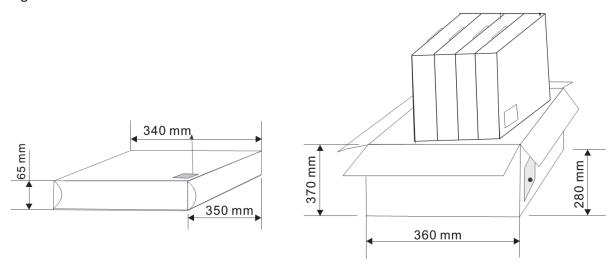


Figure 20 - Reel Packaging

17.3 Packaging Label



Figure 21 – Packaging Label

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18. Cautions

- 1) The guidelines of this document should be followed in order to assure proper performance of the module.
- 2) This product is for use in office, business, and residential applications, but not medical devices.
- 3) This module may short-circuit. If a short circuit can result in serious damage or injury then failsafe precautions should be used. This could be accomplished by redundant systems and protection circuits.
- 4) Supply voltage to the module should not be higher than the specified inputs or reversed. Additionally, it should not contain noise, spikes, or AC ripple voltage.
- 5) Avoid use with other high frequency circuits.
- 6) Use methods to eliminate static electricity when working with the module as it can damage the components.
- 7) Contact with wires, the enclosure, or any other objects should be avoided.
- 8) Refer to the recommended pattern when designing for this module.
- 9) If hand soldering is used, be sure to use the precautions outlined in this document.
- 10) This module should be kept away from heat, both during storage and after installation.
- 11) Do not drop or physically shock the module.
- 12) Do not damage the interface surfaces of the module.
- 13) The module should not be mechanically stressed at any time (storage, handling, installation).
- 14) Do not store or expose this module to:
 - Humid or salty air conditions
 - High concentrations of corrosive gasses.
 - Long durations of direct sunlight.
 - Temperatures lower than -40°C or higher than 125°C.

19. Life Support Policy

This product is not designed to be used in a life support device or system, or in applications where there is potential for a failure or malfunction to, directly or indirectly, cause significant injury. By using this product in an application that poses these risks, such as described above, the customer is agreeing to indemnify Rigado for any damages that result.

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20. Document History

Revision	Date	Changes / Notes
0.8	7/5/2017	Initial Release
1.0	5/21/2018	Production Release. Updated power specifications. Added details on REGO related silicon errata. Updated certification information. Added Zigbee information. Removed outdated factory firmware information.

21. Related Documents

Rigado Documents:

BMD-340 Product Brief

Nordic Documents:

Visit <u>infocenter.nordicsemi.com</u> for a comprehensive library of Nordic technical documentation.

- nRF52840 nRF52840 Product Specification
- nRF52840 nRF52840 Rev 1 Production Silicon Errata
- S140-SDS nRF52840 S140 Soft Device Specification
- 802.15.4 nRF5 SDK for Thread and Zigbee

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